

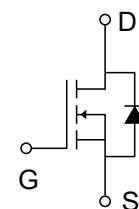
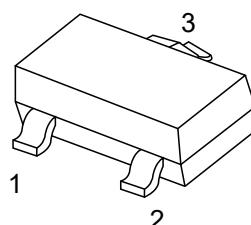
1. Description

The SI2304A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

3. Pinning information

| Pin | Symbol | Description |
|-----|--------|-------------|
| 1 | G | GATE |
| 2 | S | SOURCE |
| 3 | D | DRAIN |

SOT-23



4. Absolute Maximum Ratings $T_A = 25^\circ\text{C}$

| Parameter | Symbol | Rating | Units | |
|-----------------------------------------------------|------------------------|------------|-------|--|
| Drain-Source Voltage | V_{DS} | 30 | V | |
| Gate-Source Voltage | V_{GS} | ± 20 | | |
| Continuous Drain Current $T_J=150^\circ\text{C}$ *1 | $T_A=25^\circ\text{C}$ | I_D | A | |
| | $T_A=70^\circ\text{C}$ | | | |
| Pulsed Drain Current | I_{DM} | 16 | | |
| Power Dissipation *1 | $T_A=25^\circ\text{C}$ | P_D | | |
| | $T_A=70^\circ\text{C}$ | | | |
| Thermal Resistance.Junction- to-Ambient | $t \leq 5 \text{ sec}$ | R_{thJA} | °C/W | |
| | Steady State | | | |
| Junction Temperature | T_J | 150 | °C | |
| Storage Temperature Range | T_{STG} | -55 to 150 | | |

*1.Surface Mounted on FR4 Board,. $t \leq 5 \text{ sec}$



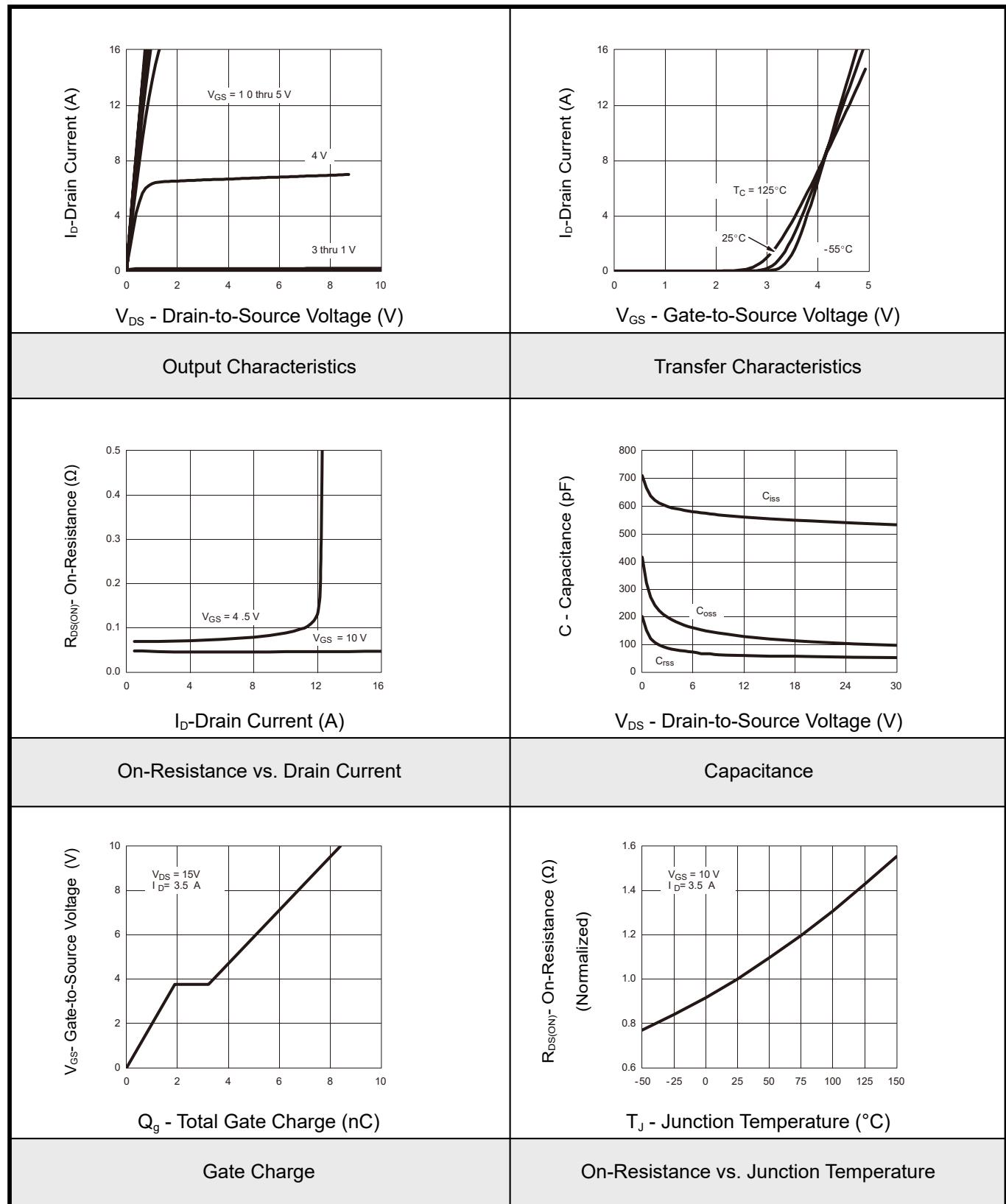
5.Electrical Characteristics $T_A = 25^\circ\text{C}$

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---------------------------------|-----------------------------|-------------------------------------------------------------|-----|------|-----------|------------------|
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $I_D=250\mu\text{A}, V_{GS}=0\text{V}$ | 30 | | | V |
| Gate threshold voltage | $V_{GS(\text{th})}$ | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$ | 1 | | 3 | V |
| Gate-body leakage | I_{GSS} | $V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=30\text{V}, V_{GS}=0\text{V}$ | | 0.5 | | μA |
| | | $V_{DS}=30\text{V}, V_{GS}=0\text{V}, T_J=55^\circ\text{C}$ | | 10 | | |
| On-state drain current | $I_{D(\text{ON})}$ | $V_{DS}\geq 4.5\text{V}, V_{GS}=10\text{V}$ | 6 | | | A |
| | | $V_{DS}\geq 4.5\text{V}, V_{GS}=4.5\text{V}$ | 4 | | | A |
| Drain-sourceon-stateresistance | $R_{DS(\text{ON})}$ | $V_{GS}=10\text{V}, I_D=3.5\text{A}$ | 27 | 35 | | $\text{m}\Omega$ |
| | | $V_{GS}=4.5\text{V}, I_D=2.8\text{A}$ | 36 | 46 | | |
| Forward transconductance | g_{FS} | $V_{DS}=4.5\text{V}, I_D=3.5\text{A}$ | 6.9 | | | S |
| Diode forward voltage | V_{SD} | $I_S=1.25\text{A}, V_{GS}=0\text{V}$ | 0.8 | 1.2 | | V |
| gate charge * | Q_g | $V_{GS}=5\text{V}, V_{DS}=15\text{V}, I_D=3.5\text{A}$ | 4.2 | 7 | | nC |
| Total gate charge * | Q_{gt} | $V_{GS}=10\text{V}$ | | 8.5 | 20 | nC |
| Gate-source charge * | Q_{gs} | | | 1.9 | | nC |
| Gate-drain charge* | Q_{gd} | | | 1.35 | | nC |
| Gate Resistance | R_g | | 0.5 | | 2.4 | Ω |
| Input capacitance * | C_{iss} | $V_{DS}=15\text{V}$ | | 555 | | pF |
| Output capacitance * | C_{oss} | | | 120 | | |
| Reverse transfer capacitance * | C_{rss} | | | 60 | | |
| Turn-on time | $t_{D(\text{on})}$ | $V_{DD}=15\text{V}, R_L=15\Omega, I_D=1\text{A}$ | | 9 | 20 | ns |
| | t_r | | | 7.5 | 18 | |
| Turn-off time | $t_{D(\text{off})}$ | | | 17 | 35 | |
| | t_f | | | 5.2 | 12 | |

* Pulse test: PW $\leq 300\text{us}$ duty cycle $\leq 2\%$.

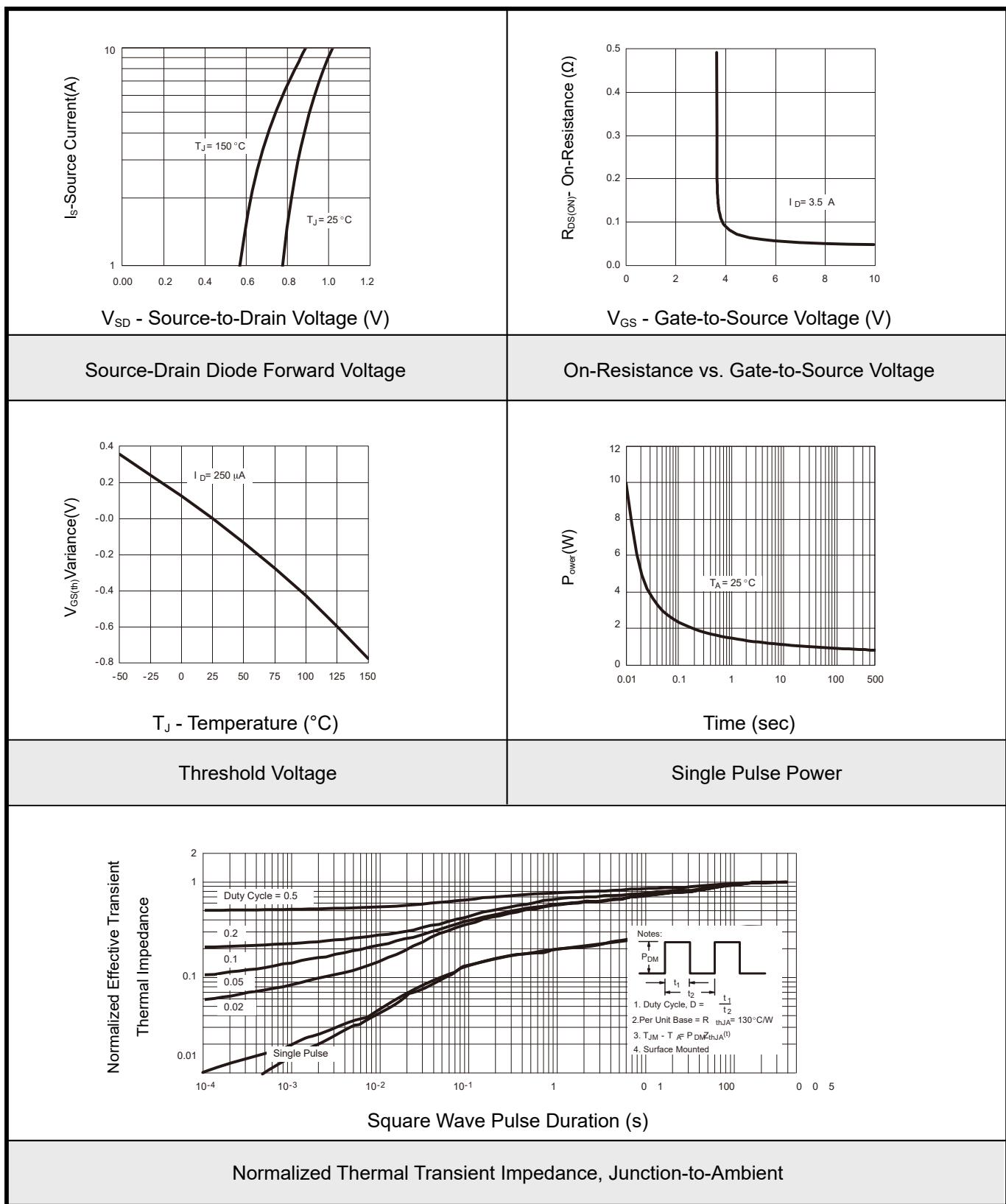


6.1 Typical Characteristics



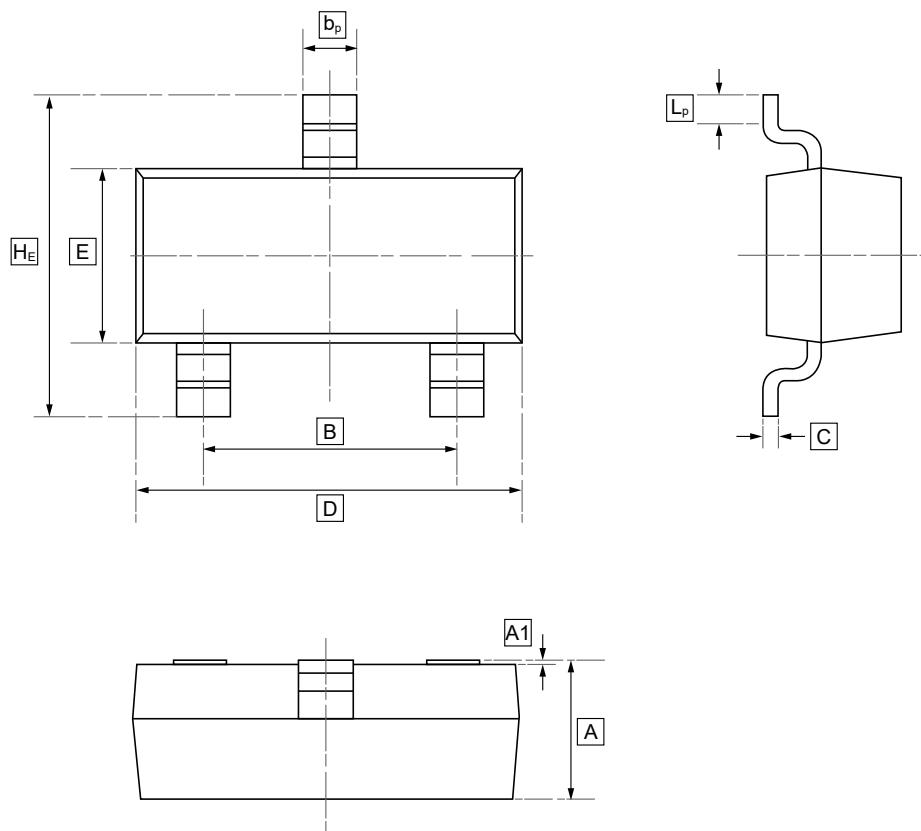


6.2 Typical Characteristics





7.SOT-23 Package Outline Dimensions

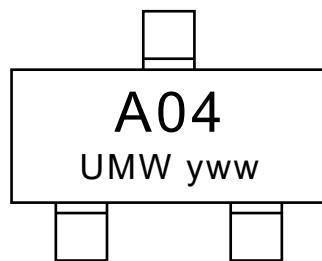


DIMENSIONS (mm are the original dimensions)

| Symbol | A | B | b _p | C | D | E | H _E | A1 | L _p |
|------------|------|------|----------------|------|------|------|----------------|-------|----------------|
| Min | 0.95 | 1.78 | 0.35 | 0.08 | 2.70 | 1.20 | 2.20 | 0.013 | 0.20 |
| Max | 1.40 | 2.04 | 0.50 | 0.19 | 3.10 | 1.65 | 3.00 | 0.100 | 0.50 |



8.Ordering information



yww: Batch Code

| Order Code | Package | Base QTY | Delivery Mode |
|-------------|---------|----------|---------------|
| UMW SI2304A | SOT-23 | 3000 | Tape and reel |



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